

Specialty Materials

Epoxy preprag, Adhesive & Composite

Product list



Phenoxy Resin / PKHH

High Tg Epoxy Resin

Curing Agents

Flame Retardants

Polymer & materials

Silane Coupling Agent

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Phenoxy Resin / PKHH, PKHP-200

Phenoxy resin have excellent adhesion to glass and carbon fibers. Phenoxy sizings enable excellent compatibility with epoxy-based matrix resins, and with vinyl ester based resins.

 Application: Coatings, Inks, Adhesives, Composites, Plastics, Electronics, Films, Fibers

Main Properties: Hardness, Impact Resistance, Vapor Barrier, Tough Flexibility, Chemical Resistance, Adhesive to Different Substrate, Abrasion Resistance, Heat Resistance, Compatibility Product Phenoxy Resin

CAS Number 25068-38-6

Mw (av.), daltons 32,000 – 60,000

Appearance Granule / Powder

Epoxy Resin

Glyether@MFN-3000 is a polyfunctional epoxy novolac resin, which is available as a solid.

Product	APPLICATION		
MFN-3000	Electrics, CCL, FCCL, BAG package		
MFN-3000EK80	Electrics, CCL, FCCL, BAG package		

HIGH Tg Special , THPE type Epoxy Resin

Product	APPLICATION
EJ-3350	Electrics, Adhesive, CCL, EMC

Bismaleimide

BMI is a bismaleimide resin that cures via an additional / free radical mechanism resulting in a cross-linked thermoset system with no condensation by-products.

Product	Chemical name	CAS
ВМІ	4,4'Diphenylmethane bismaleimide	13676-54-5
BMI-70	Bis (3-Ethyl-5-Methyl-4 Maleimidephenyl Methane	105391-33-1
BMI-80	2,2'-Bis[4-(4-Maleimide phenoxy)Phenyl propane	79922-55-7
BMI-122	Polyphenyl methane bismaleimide	
BMI-400	Resin based on Discitraconimide 70% in MEK	

Special Amine

One of the most important feature of MXD6 is that it has the only best gas barrier property in all kinds of commercial nylon plastics, which can be used to limit access of oxygen and carbon dioxide, and then it is more widely used than EVOH, PAN and PVDC in practical application.

Flame retardant

Flame retardant is used as an additive for epoxy resins and polycarbonates, as well as other engineering and high performance polymers. Flame retardant shows a great stability at high temperatures and a predominant hydrolysis resistance. It is mainly applied in high value-added products for electric & electronic and medical devices.

Chemical	CAS	Equivalent
Poly(bis(phenoxy)phosphazene) Oligomer	28212-48-8	SPB-100
Aluminum diethylphosphinate	225789-38-8	OP-935
Phenoxyphosphazene Oligomer		Rabitle FP100

MWCT (Multi-wall Carbon Nanotubes)

- Improve the impact resistance & shear resistance.
- Improve fracture toughness, tensile strength and flexural strength.
- Reduce weight of final fiber reinforced composite materials.

Product	Purity	Diameter	Length	Layer
S-Tube 100	97%	12 – 15 nm	3 – 15 um	8 – 15
S-Tube 120	97%	20 – 30 nm	3 – 15 nm	12 - 20
S-Tube 150	97%	12 – 15 nm	0.5 – 5 um	8 - 15
S-Tube 400	95%	80 – 150 nm	0.5 – 5 um	50 - 65
S-Tube 500	95%	50 – 200 nm	0.5 – 5 um	63 - 90

Silane Coupling Agent

We provide specialty-wise silane coupling agent according to user's requesting including all commodity silane grades.

Product	Chemical name	CAS
FC-25	3-Isocyanatopropyltriethoxysilane	24801-88-5
FC-24	3-Isocyanatopropyltrimethoxysilane	15396-00-6
JH-O187	3-Glycidyloxypropyltrimethoxysilane	2530-83-8
JH-VP12	Vinyl silane oligomer	
JH-AP10	Amino silane solution	
JH-A110	3-Aminopropltriethoxysilane	919-30-2
JH- A112	N-(2-Aminoethyl)-3-aminopropyltrim ethoxysilane	1760-24-3
TEOS	Tetraethoxysilane	78-10-4



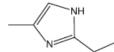


Imidazole



2M

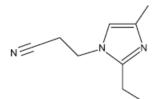
2-Methylimidazole CAS: 693-98-1



2E4MZ

2-Ethyl-4-methylimidazole

CAS: 931-36-2



1CN2E4M

1-Cyanoethyl-2-Ethyl-4-methylimidazole

CAS: 23996-25-0

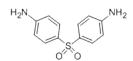


DMI

1,2-Dimethylimidazole CAS: 1739-84-0

Epoxy Curing agent

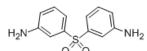
Sulfone type



4.4' DDS

4,4'-Diamino Diphenyl Sulphone

CAS: 80-08-0

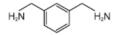


3,3' DDS

3,3'-Diamino Diphenyl Sulphone

CAS: 599-61-1

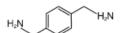
• Amine Type



MXDA

1,3-BIS(AMINOMETHYL)BENZENE

CAS: 1477-55-8



PXDA

1,4-BIS(AMINOMETHYL)BENZENE

CAS: 539-48-0

$$H_2N$$
 NH_2

1,3-BAC

CAS: 2579-20-6

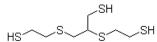
1,4-BAC

CAS: 2549-93-1

BDMA

CAS: 103-83-3

• Mercaptan Type



SCMDO

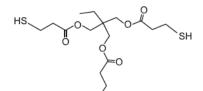
CAS: 131538-00-6

SCDO

CAS 14970-87-7

PETMP

CAS: 7575-23-7



TMPMP

CAS: 33007-83-9

Specialty-wise materials

H₀NH₂

NBDA

CAS: 56602-77-8

O U N=C=O

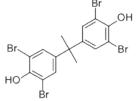
IPDI

CAS: 4098-71-9

P=N

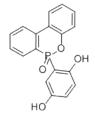
Poly(bis(phenoxy)phosphazene

CAS: 28212-48-8



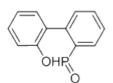
Tetrabromobisphenol A

CAS: 79-94-7



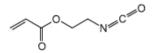
DOPO-HQ

CAS: 99208-50-1



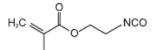
DOPO

CAS: 35948-25-5



SP-AO

CAS: 13641-96-8

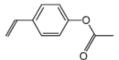


SP-MOI

CAS: 30674-80-7

TODI

CAS: 91-97-4



4-Acetoxystyrene CAS: 2628-16-2

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DMDEE

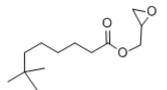
CAS: 6425-39-4

BDMAEE

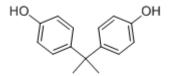
CAS: 3033-62-3

BF3

CAS: 75-23-0



CARDURA E-10P CAS: 26761-45-5



Bisphenol A CAS: 80-05-7







With our market intelligence and international network of Partners, We can provide real advantage to the composites Industry.

For further information, Please visit our website at www.seechem.com

We don't neglect even tiny inquiry.

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